

# Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Overlay		0mm	
2		Top Solder	Solder Resist	0.01501mm	3.5
3		Top Copper		0.035mm	
4		Dielectric 1	FR-4	0.35999mm	4.6
5		Supply	CF-004	0.035mm	
6		Dielectric 4	PP-006	0.07112mm	4.1
7		Signal Layer 1		0.035mm	
8		Dielectric 2	FR-4	0.7mm	4.6
9		Signal Layer 2		0.035mm	
10		Dielectric 5	PP-006	0.07112mm	4.1
11		GND	CF-004	0.035mm	
12		Dielectric 3	FR-4	0.35999mm	4.6
13		Bot Copper		0.035mm	
14		Bottom Solder	Solder Resist	0.01501mm	3.5
15		Bottom Overlay		0mm	
	Height : 1.80226mm				